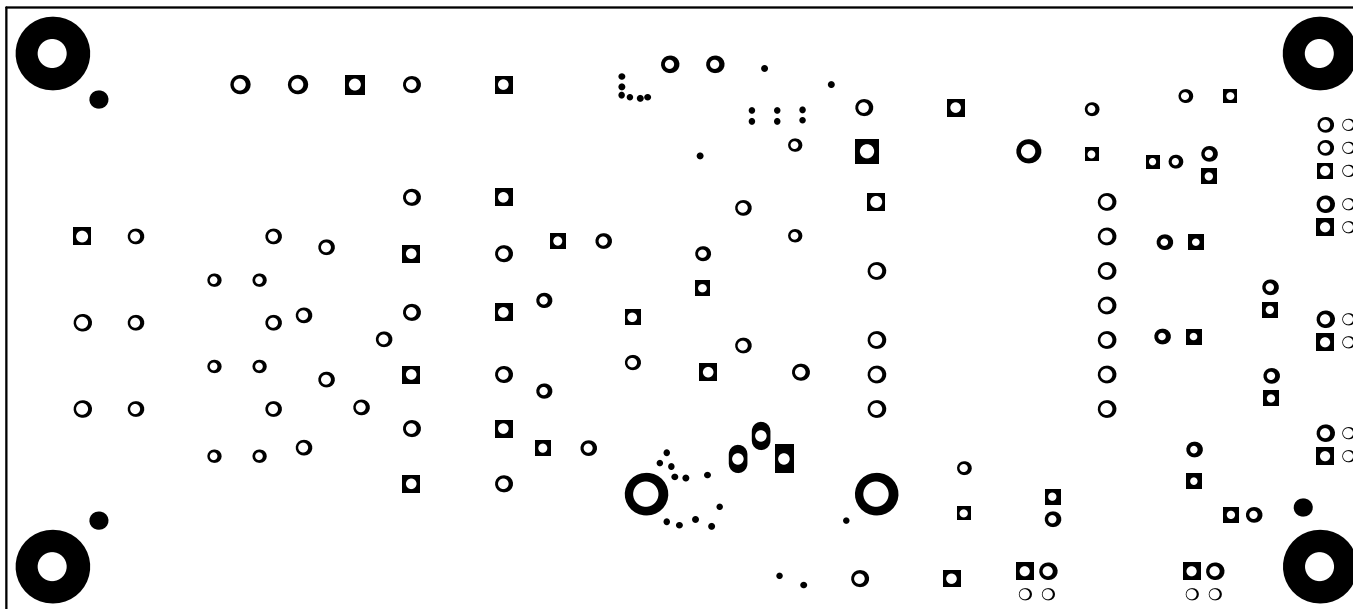
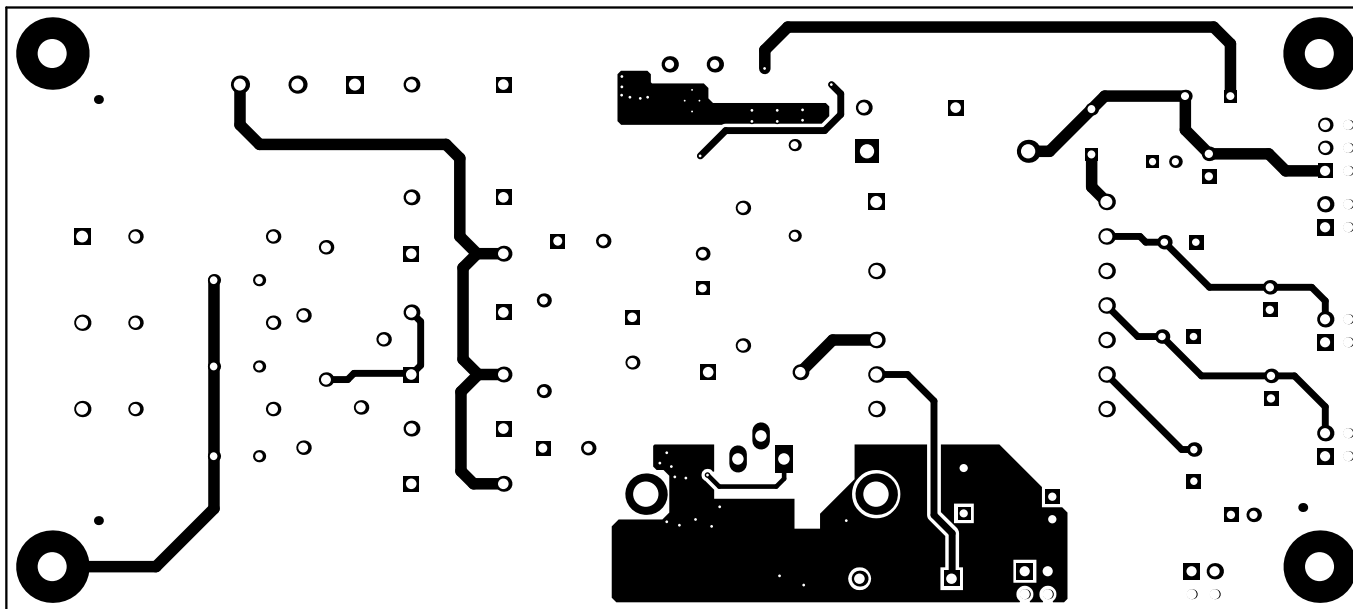


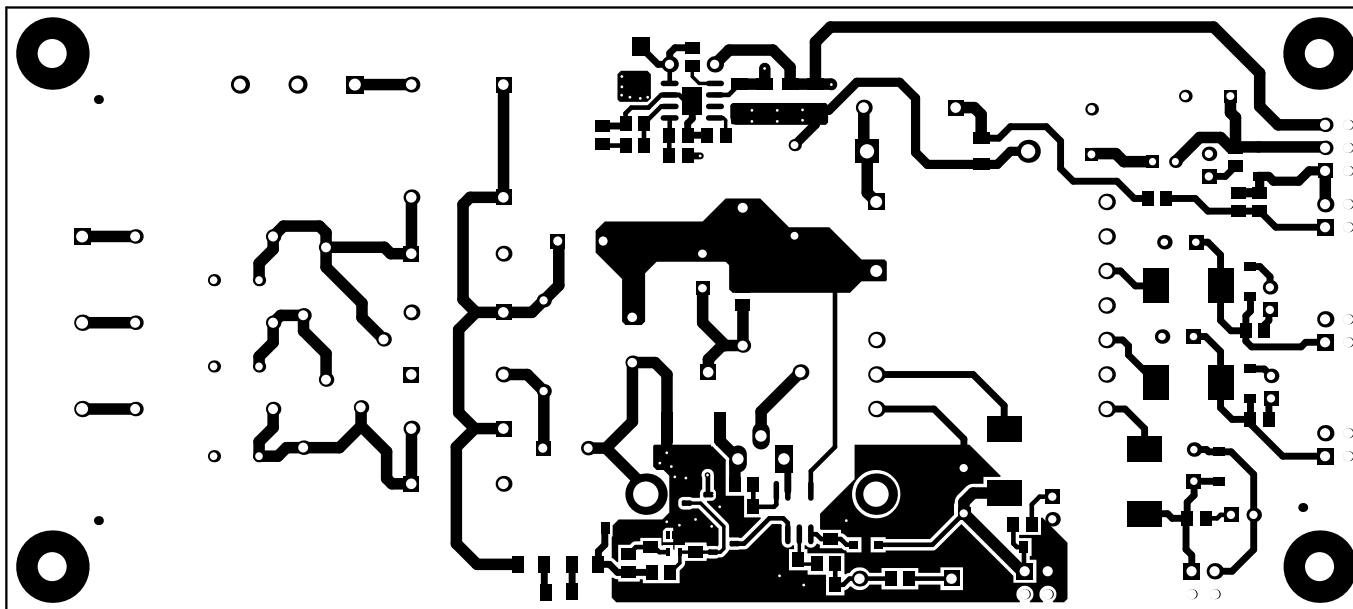
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LAYER NAME= Top Overlay			
PLOT NAME=Top Overlay	GENERATED : 8/21/2015	3:20:32 PM	TEXAS INSTRUMENTS



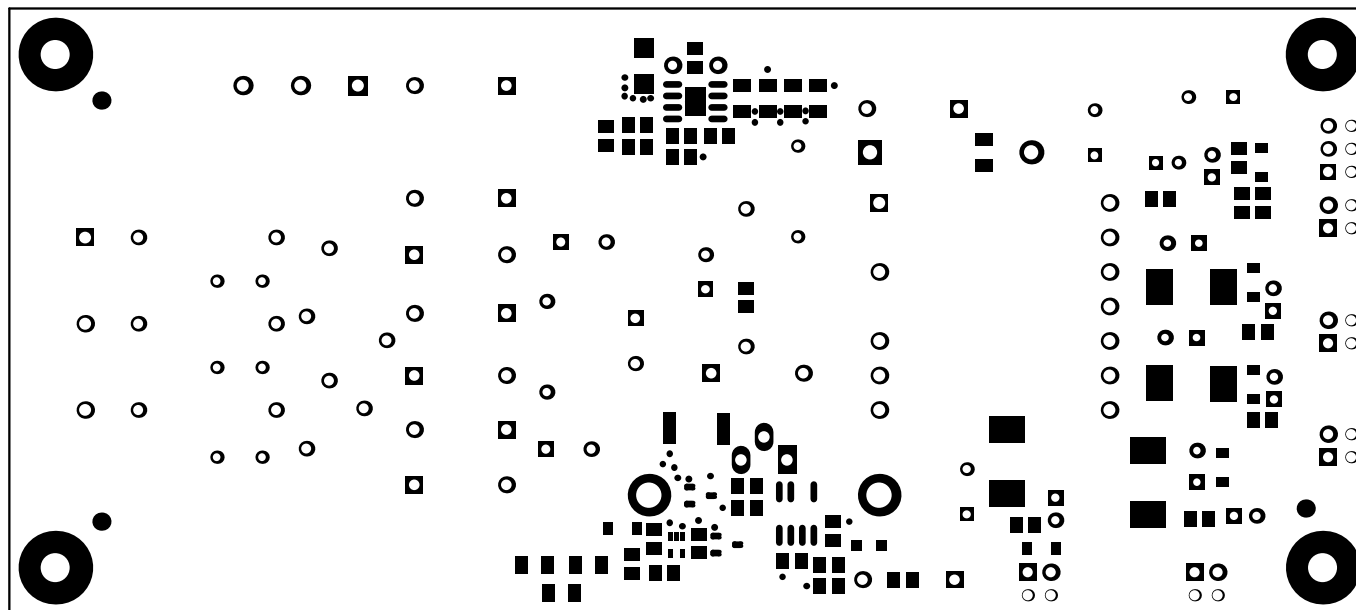
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Top Solder			
PLOT NAME=Top Solder Mask	GENERATED : 8/21/2015	3:20:32 PM	TEXAS INSTRUMENTS



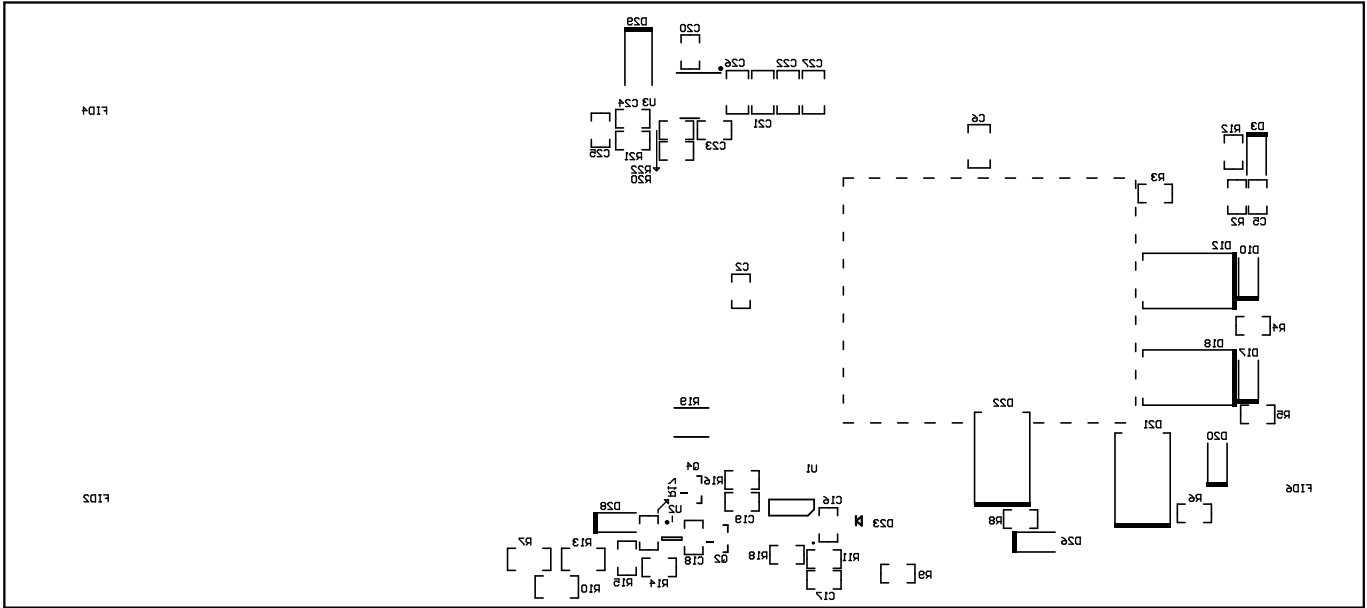
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Top Layer			
PLOT NAME=Top Layer	GENERATED : 8/21/2015	3:20:32 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Bottom Layer			
PLOT NAME=Bottom Layer	GENERATED : 8/21/2015	3:20:33 PM	TEXAS INSTRUMENTS



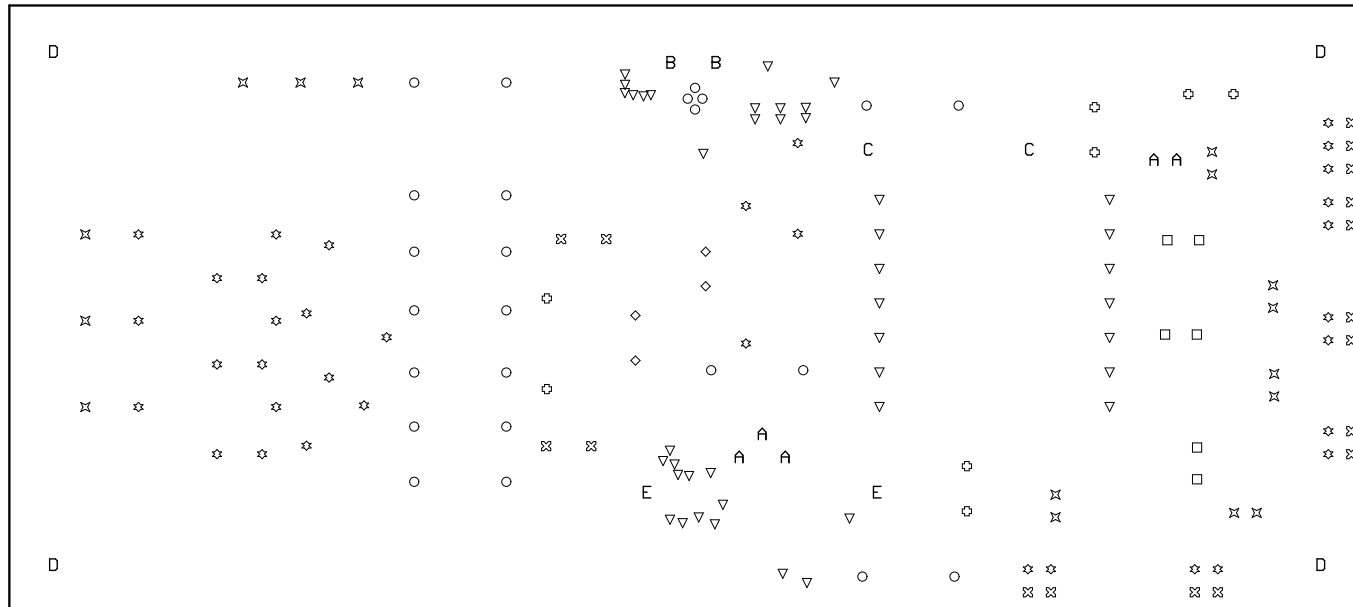
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Bottom Solder			
PLOT NAME=Bottom Solder Mask	GENERATED : 8/21/2015	3:20:33 PM	TEXAS INSTRUMENTS



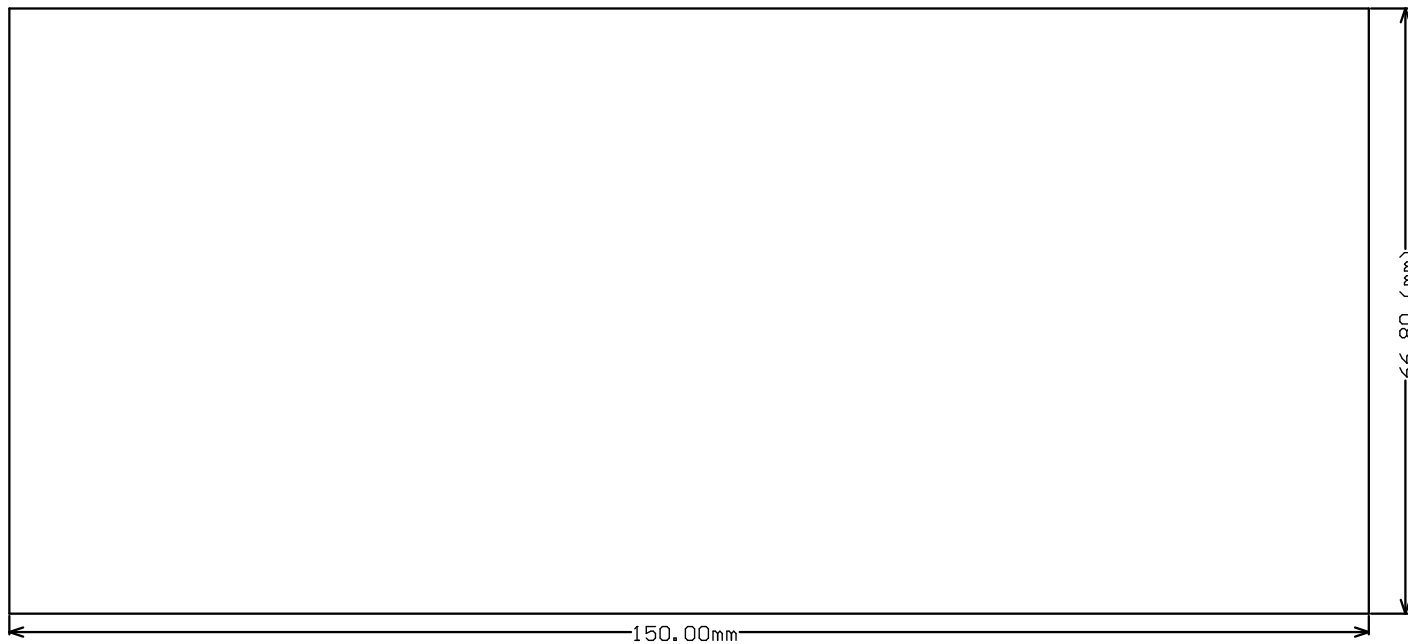
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Bottom Overlay			
PLOT NAME=Bottom Overlay	GENERATED : 8/21/2015	3:20:33 PM	TEXAS INSTRUMENTS

⊗	8	33.465mil (0.85mm)	PTH	Round
⊗	4	35mil (0.889mm)	PTH	Round
⊗	4	35.433mil (0.9mm)	PTH	Round
⊗	10	35.984mil (0.914mm)	PTH	Round
◇	2	37mil (0.94mm)	PTH	Round
⊗	4	39.37mil (1mm)	PTH	Round
B	2	40mil (1.016mm)	PTH	Round
◇	2	41.496mil (1.054mm)	PTH	Round
⊗	27	43.307mil (1.1mm)	PTH	Round
⊗	13	43.407mil (1.103mm)	NPTH	Round
○	20	45.276mil (1.15mm)	PTH	Round
A	3	50mil (1.27mm)	PTH	Round
⊗	6	51.181mil (1.3mm)	PTH	Round
▽	14	51.968mil (1.32mm)	PTH	Round
C	2	62mil (1.575mm)	PTH	Round
E	2	110.236mil (2.8mm)	PTH	Round
D	4	125.984mil (3.2mm)	PTH	Round
		168 Total		

Drill Table
 DRILL TOLERANCE
 FOR PTH +/- 3MIL
 FOR NPTH +/- 3MIL
 7.874mil drill:+0/-7.874mil
 12mil drill:+0/-12mil



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= Drill Drawing			
PLOT NAME=Drill Drawing	GENERATED : 8/21/2015	3:20:34 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00315	REV: E1	SUN REV: Not In VersionControl
LAYER NAME=			
PLOT NAME=Board Dimensions	GENERATED	: 8/21/2015 3:20:34 PM	TEXAS INSTRUMENTS

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